

3A, 400V ESD Capability Rectifier

FEATURES

- High ESD capability
- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- AEC-Q101 qualified available:
ordering code with suffix "H"
- Compliant to RoHS Directive 2011/65/EU and
in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_{F(AV)}$	3	A
V_{RRM}	400	V
I_{FSM}	100	A
V_F at $I_F=3A$	1	V
T_{JMAX}	175	°C
Package	DO-214AB (SMC)	
Configuration	Single die	

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter



MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.21 g (approximately)



DO-214AB (SMC)

SOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	TSD3G	UNIT
Marking code on the device		TSD3G	
Repetitive peak reverse voltage	V_{RRM}	400	V
Reverse voltage, total rms value	$V_{R(RMS)}$	280	V
Forward current	$I_{F(AV)}$	3	A
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I_{FSM}	100	A
Junction temperature	T_J	- 55 to +175	°C
Storage temperature	T_{STG}	- 55 to +175	°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	21	$^{\circ}C/W$
Junction-to-ambient thermal resistance	$R_{\theta JA}$	59	$^{\circ}C/W$
Junction-to-case thermal resistance	$R_{\theta JC}$	22	$^{\circ}C/W$

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 1.5A, T_J = 25^{\circ}C$	V_F	0.85	0.95	V
	$I_F = 3A, T_J = 25^{\circ}C$		0.89	1.00	V
	$I_F = 1.5A, T_J = 125^{\circ}C$		0.72	0.90	V
	$I_F = 3A, T_J = 125^{\circ}C$		0.76	1.00	V
Reverse current @ rated V_R ⁽²⁾	$T_J = 25^{\circ}C$	I_R	-	1	μA
	$T_J = 125^{\circ}C$		-	50	μA
Junction capacitance	1 MHz, $V_R=4.0V$	C_J	45	-	pF

Notes:

1. Pulse test with PW=0.3 ms
2. Pulse test with PW=30 ms

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25^{\circ}C$ unless otherwise noted)						
Standard	Test Type	Test Conditions	SYMBOL	CLASS	Value	Typical
AEC-Q101-001	Human body model(contact mode)	$C=100pF, R=1.5k\Omega$	V_c	H3B	$\geq 8kV$	N/A
IEC 61000-4-2	Contact mode	$C=150pF, R=330\Omega$		4	$\geq 8kV$	25kV
	Air-discharge mode	$C=150pF, R=330\Omega$		4	$\geq 15kV$	30kV
ISO 10605	Contact mode	$C=330pF, R=330\Omega$		L4	$\geq 15kV$	25kV
	Air-discharge mode	$C=330pF, R=330\Omega$		L4	$\geq 25kV$	30kV

ORDERING INFORMATION		
ORDERING CODE (Note 1)	PACKAGE	PACKING
TSD3GHR7G	SMC	850 / 7" Plastic reel
TSD3GHR6G	SMC	3,000 / 13" Paper reel
TSD3GHM6G	SMC	3,000 / 13" Plastic reel
TSD3G R7G	SMC	850 / 7" Plastic reel
TSD3G R6G	SMC	3,000 / 13" Paper reel
TSD3G M6G	SMC	3,000 / 13" Plastic reel

Note:

1. "H" means AEC-Q101 qualified

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

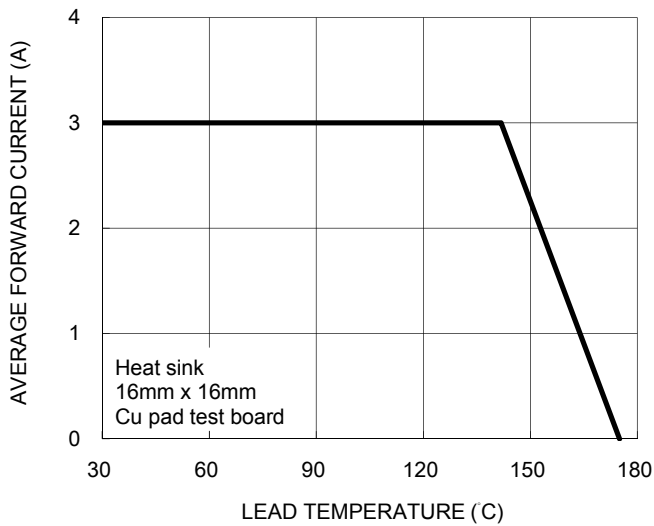


Fig.2 Typical Junction Capacitance

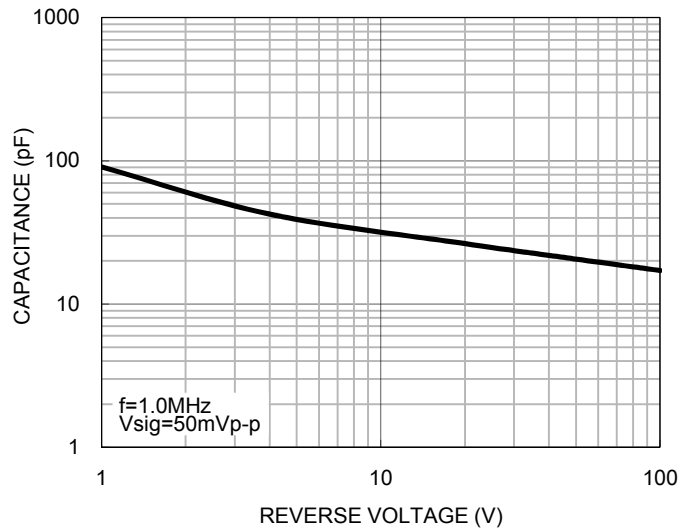


Fig.3 Typical Reverse Characteristics

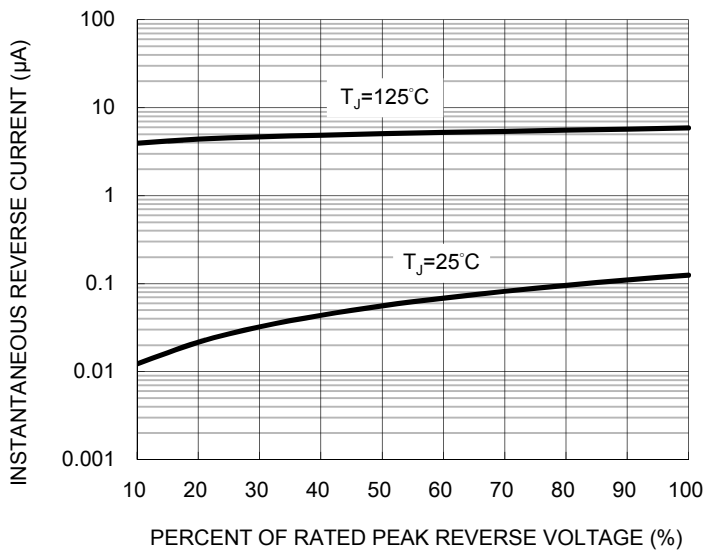
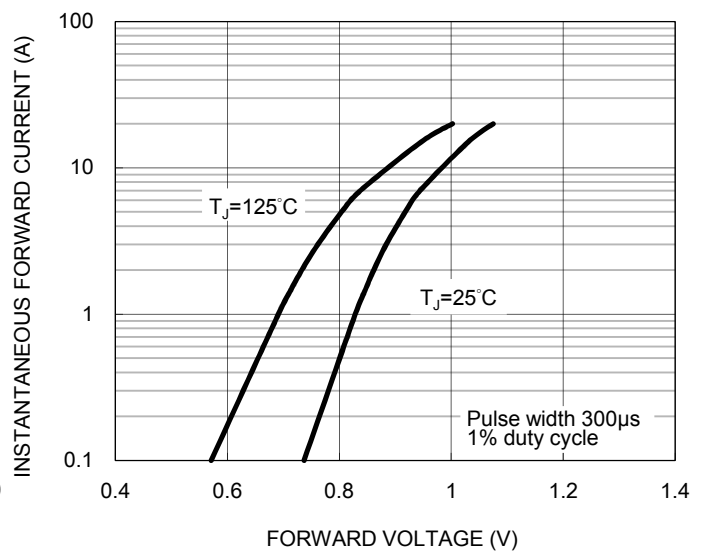
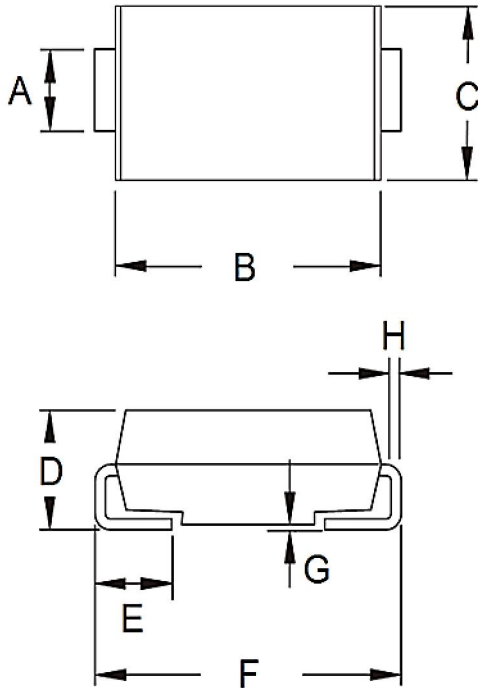


Fig.4 Typical Forward Characteristics



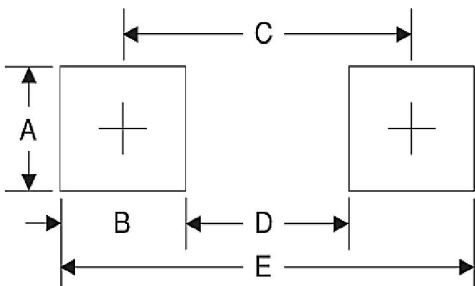
PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	2.90	3.20	0.114	0.126
B	6.60	7.11	0.260	0.280
C	5.59	6.22	0.220	0.245
D	2.00	2.62	0.079	0.103
E	1.00	1.60	0.039	0.063
F	7.75	8.13	0.305	0.320
G	0.10	0.20	0.004	0.008
H	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.80	0.268
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



SMC

- P/N =Marking Code
- G =Green Compound
- YW =Date Code
- F =Factory Code

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